

PATENT APPLICATION
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Docket No: Q78564

Nobuo UOTANI, et al.

Appln. No.: 10/579,406

Group Art Unit: 2812

Confirmation No.: 1349

Examiner: Unknown

Filed: May 15, 2006

For: POLISHING COMPOSITION AND POLISHING METHOD

REQUEST FOR CORRECTED OFFICIAL FILING RECEIPT

ATTN: Office of Initial Patent Examination
Filing Receipt Correction
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

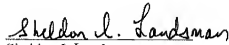
We enclose a copy of the Official Filing Receipt for the above-identified application and request the following correction:

Assignment for Published Patent Application

SHOWA DENKO K.K.

Verification for the requested correction is indicated on the Assignment Document filed May 15, 2006.

Respectfully submitted,


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WASHINGTON OFFICE

23373

CUSTOMER NUMBER

Date: February 2, 2007



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APPL. NO.	FILING OR 371 (c) DATE	ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLMS	IND CLMS
10/579,406	05/15/2006	2812	2150	Q78564	3	45	1

CONFIRMATION NO. 1349

23373
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FILING RECEIPT



OC000000021809936

Date Mailed: 01/03/2007

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please mail to the Commissioner for Patents P.O. Box 1450 Alexandria Va 22313-1450. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

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 Hiroshi Takahashi, Nagano, JAPAN; ✓
 Takashi Sato, Nagano, JAPAN; ✓
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ASSIGNMENT FOR PUBLISHED PATENT APPLICATION
SHOJI DENKO K.K.

Power of Attorney: The patent practitioners associated with Customer Number 23373.

Domestic Priority data as claimed by applicant

This application is a 371 of PCT/JP04/17318 11/15/2004 ,
 which claims benefit of 60/523,684 11/21/2003 ✓
 and claims benefit of 60/526,263 12/03/2003 ✓
 and claims benefit of 60/571,525 05/17/2004 ✓

Foreign Applications

JAPAN 2003-385253 11/14/2003 ✓
 JAPAN 2003-394081 11/25/2003 ✓
 JAPAN 2003-398523 11/28/2003 ✓
 JAPAN 2004-135358 04/30/2004 ✓

If Required, Foreign Filing License Granted: 12/31/2006

The country code and number of your priority application, to be used for filing abroad under the Paris Convention, is **US10/579,406**

U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter "ASSIGNOR") by

(Insert
ASSIGNEE's
Name(s)
Address(es))

SHOWA DENKO K.K.

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(hereinafter "ASSIGNEE"), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled

(Title of
Invention)

POLISHING COMPOSITION AND POLISHING METHOD

relating to International Patent Application PCT/JP 2004, 017318 and/or for which application for Letters Patent of the United States was executed on even date herewith or, if not so executed, was:

(Insert date
of execution
of application,
if not
concurrent)

(a) executed on _____

(b) filed on _____
Serial No. _____

_____ is hereby authorized to insert in (b) the specified data, when known.

and to said application and all Letters Patent(s) of the United States granted on said application and any continuation, division, renewal, substitute, reissue or reexamination application based thereon, for the full term or terms for which the said Letters Patent(s) may be granted and including any extensions thereof (collectively, hereinafter, "said application(s) and Letters Patent(s)").

The ASSIGNOR agrees(s), when requested by said ASSIGNEE and without charge to but at the expense of said ASSIGNEE, to do all acts which the ASSIGNEE may deem necessary, desirable or expedient, for securing, maintaining and enforcing protection for said invention, including in the preparation and prosecution of said application(s) and the issuance of said Letters Patent(s), in any interference, reissue, reexamination, or public use proceeding, and in any litigation or other legal proceeding which may arise or be declared in relation to same, such acts to include but not be limited to executing all papers, including separate assignments and declarations, taking all rightful oaths, providing sworn testimony, and obtaining and producing evidence.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

(Signature)

<u>Nobuo Uotani</u> (SIGNATURE)	<u>Nobuo Uotani</u> (TYPE NAME)	<u>7/April/2006</u> (DATE)
<u>Hiroshi Takahashi</u> (SIGNATURE)	<u>Hiroshi Takahashi</u> (TYPE NAME)	<u>7/April/2006</u> (DATE)
<u>Takashi Sato</u> (SIGNATURE)	<u>Takashi Sato</u> (TYPE NAME)	<u>7/April/2006</u> (DATE)
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